

# ANALOG Wideband, 40 dB Isolation at 1 GHz, CMOS DEVICES 1.65 V to 2.75 V SPST Switches 1.65 V to 2.75 V, SPST Switches

## ADG901/ADG902

### **FEATURES**

Wideband switch: -3 dB @ 4.5 GHz ADG901—absorptive switch ADG902—reflective switch High off isolation: 40 dB @ 1 GHz Low insertion loss: 0.8 dB @1 GHz Single 1.65 V to 2.75 V power supply **CMOS/LVTTL** control logic 8-lead MSOP and tiny 3 mm × 3 mm LFCSP packages

Low power consumption (<1  $\mu$ A)

### **APPLICATIONS**

Wireless communications **General purpose RF switching Dual-band applications High speed filter selection** Digital transceiver front end switch IF switching **Tuner modules** Antenna diversity switching list

### **GENERAL DESCRIPTION**

The ADG901/ADG902 are wideband switches that use a CMOS process to provide high isolation and low insertion loss to 1 GHz. The ADG901 is an absorptive (matched) switch with 50  $\Omega$  terminated shunt legs, while the ADG902 is a reflective switch. These devices are designed such that the isolation is high over the dc to 1 GHz frequency range. They have on-board CMOS control logic, thus eliminating the need for external controlling circuitry. The control inputs are both CMOS and

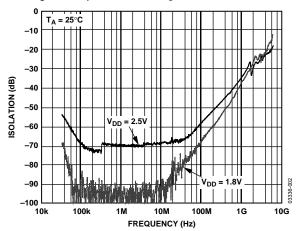
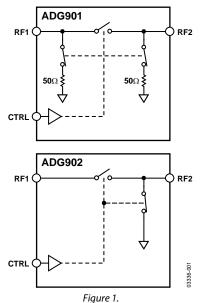


Figure 2. Off Isolation vs. Frequency

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### **FUNCTIONAL BLOCK DIAGRAM**



LVTTL compatible. The low power consumption of these CMOS devices makes them ideally suited to wireless applications and general-purpose high frequency switching.

### **PRODUCT HIGHLIGHTS**

- -40 dB Off Isolation @ 1 GHz
- 0.8 dB Insertion Loss @ 1 GHz
- Tiny 8-Lead MSOP/LFCSP Packages

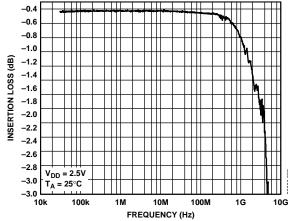


Figure 3. Insertion Loss vs. Frequency

## IMPORTANT LINKS for the <a href="mailto:aDG901\_902">ADG901\_902</a>\*

Last content update 08/17/2013 12:41 am

### PARAMETRIC SELECTION TABLES

Choosing the Correct Switch or Multiplexer for Your Application Switches and Multiplexers Product Selection Guide

#### **DOCUMENTATION**

**AN-952:** ADG9xx Wideband CMOS Switches: Frequently Asked Questions

Use Circuits from the Lab™ in Your Next Design

CMOS Switches Offer High Performance in Low Power, Wideband Applications

Enhanced Multiplexing for MEMS Optical Cross Connects RF Source Booklet

### **EVALUATION KITS & SYMBOLS & FOOTPRINTS**

View the Evaluation Boards and Kits page for the ADG901 View the Evaluation Boards and Kits page for the ADG902 Symbols and Footprints for the ADG901 Symbols and Footprints for the ADG902

### **DESIGN COLLABORATION COMMUNITY**



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**Quality and Reliability Lead(Pb)-Free Data** 

#### **SAMPLE & BUY**

ADG901 ADG902

- View Price & Packaging
- Request Evaluation Board
- Request Samples Check Inventory & Purchase

**Find Local Distributors** 



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## **SPECIFICATIONS**

 $V_{DD} = 1.65 \text{ V}$  to 2.75 V, GND = 0 V, input power = 0 dBm, all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise specified.

Table 1.

				B Version		
Parameter	Symbol	Conditions	Min	Typ <sup>2</sup>	Max	Unit
AC ELECTRICAL CHARACTERISTICS						
Operating Frequency <sup>3</sup>			DC		2.5	GHz
−3 dB Frequency⁴					4.5	GHz
Input Power⁴		0 V dc bias			7	dBm
		0.5 V dc bias			16	dBm
Insertion Loss	S <sub>21</sub> , S <sub>12</sub>	DC to 100 MHz; $V_{DD} = 2.5 \text{ V} \pm 10\%$		0.4	0.7	dB
		$500 \text{ MHz}$ ; $V_{DD} = 2.5 \text{ V} \pm 10\%$		0.5	0.8	dB
		1000 MHz; $V_{DD} = 2.5 \text{ V} \pm 10\%$		0.8	1.25	dB
Isolation—RF1 to RF2	S <sub>21</sub> , S <sub>12</sub>	100 MHz	60	61		dB
CP Package		500 MHz	43	45		dB
		1000 MHz	34	40		dB
Isolation—RF1 to RF2	S <sub>21</sub> , S <sub>12</sub>	100 MHz	51	60		dB
RM Package		500 MHz	37.5	47		dB
		1000 MHz	31	37		dB
Return Loss (On Channel) <sup>4</sup>	S <sub>11</sub> , S <sub>22</sub>	DC to 100 MHz	20	28		dB
		500 MHz	23	29		dB
		1000 MHz	25	28		dB
Return Loss (Off Channel) <sup>4</sup>	S <sub>11</sub> , S <sub>22</sub>	DC to 100 MHz	18	23		dB
		500 MHz	17	21		dB
		1000 MHz	15	19		dB
On Switching Time <sup>4</sup>	t <sub>ON</sub>	50% CTRL to 90% RF		3.6	6	ns
Off Switching Time <sup>4</sup>	toff	50% CTRL to 10% RF		5.8	9.5	ns
Rise Time <sup>4</sup>	t <sub>RISE</sub>	10% to 90% RF		3.1	5.5	ns
Fall Time <sup>4</sup>	t <sub>FALL</sub>	90% to 10% RF		6.0	8.5	ns
1 dB Compression <sup>4</sup>	$P_{-1 dB}$	1000 MHz		17		dBm
Third-Order Intermodulation Intercept	IP3	900 MHz/901 MHz, 4 dBm	28.5	36		dBm
Video Feedthrough <sup>5</sup>				2.5		mV p-
DC ELECTRICAL CHARACTERISTICS						
Input High Voltage	V <sub>INH</sub>	$V_{DD} = 2.25 \text{ V to } 2.75 \text{ V}$	1.7			V
. 3	V <sub>INH</sub>	V <sub>DD</sub> = 1.65 V to 1.95 V	0.65 V <sub>DD</sub>			V
Input Low Voltage	V <sub>INL</sub>	$V_{DD} = 2.25 \text{ V to } 2.75 \text{ V}$			0.7	V
	V <sub>INL</sub>	V <sub>DD</sub> = 1.65 V to 1.95 V			0.35	V
					$V_{\text{DD}}$	
Input Leakage Current	l <sub>i</sub>	$0 \le V_{\text{IN}} \le 2.75 \text{ V}$		±0.1	±1	μΑ
CAPACITANCE <sup>4</sup>						
RF1/RF2, RF Port On Capacitance	C <sub>RF</sub> on	f = 1 MHz		1.2		рF
CTRL Input Capacitance	$C_{CTRL}$	f = 1 MHz		2.1		pF
POWER REQUIREMENTS						
$V_{DD}$			1.65		2.75	V
Quiescent Power Supply Current	I <sub>DD</sub>	Digital inputs = $0 \text{ V or V}_{DD}$		0.1	1	μΑ

<sup>&</sup>lt;sup>1</sup> Temperature range for B version:  $-40^{\circ}$ C to  $+85^{\circ}$ C.

<sup>2</sup> Typical values are at V<sub>DD</sub> = 2.5 V and 25°C, unless otherwise specified.

<sup>3</sup> Point at which insertion loss degrades by 1 dB.

<sup>4</sup> Guaranteed by design, not subject to production test.

<sup>5</sup> The dc transience at the output of any port of the switch when the control voltage is switched from high to low or low to high in a 50 Ω test setup, measured with 1 ns rise time pulses and 500 MHz bandwidth.

### **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25$ °C, unless otherwise specified.

Table 2.

1 able 2.	
Parameter	Rating
V <sub>DD</sub> to GND	-0.5 V to +4 V
Inputs to GND	$-0.5 \text{ V to V}_{DD} + 0.3 \text{ V}^{1}$
Continuous Current	30 mA
Input Power	18 dBm
Operating Temperature Range	
Industrial (B Version)	-40°C to +85°C
Storage Temperature Range	−65°C to +150°C
Junction Temperature	150°C
MSOP Package	
$\theta_{JA}$ Thermal Impedance	206°C/W
LFCSP Package	
$\theta_{JA}$ Thermal Impedance (2-Layer board)	84°C/W
$\theta_{JA}$ Thermal Impedance (4-Layer board)	48°C/W
Lead Temperature, Soldering (10 sec)	300°C
IR Reflow, Peak Temperature (<20 sec)	235°C
ESD	1 kV

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ESD CAUTION**

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



 $<sup>^{1}</sup>$  RF1/RF2 off port inputs to ground:  $-0.5\ V$  to  $V_{\text{DD}}$  –  $0.5\ V$ 

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

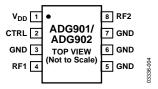


Figure 4. 8-Lead MSOP (RM-8) and 8-Lead 3 mm × 3 mm LFCSP (CP-8 – Exposed pad tied to substrate, GND

### **Table 3. Pin Function Descriptions**

Pin No.	Mnemonic	Description
1	V <sub>DD</sub>	Power Supply Input. These parts can be operated from 1.65 V to 2.75 V; V <sub>DD</sub> should be decoupled to GND.
2	CTRL	CMOS or LVTTL Logic Level. CTRL input should not exceed VDD.
		$0 \rightarrow RF1$ Isolated from RF2.
		$1 \rightarrow RF1$ to RF2.
3, 5, 6, 7	GND	Ground Reference Point for All Circuitry on the Part.
4	RF1	RF1 Port.
8	RF2	RF2 Port.

### Table 4. Truth Table

CTRL	Signal Path
0	RF1 isolated from RF2
1	RF1 to RF2

### TYPICAL PERFORMANCE CHARACTERISTICS

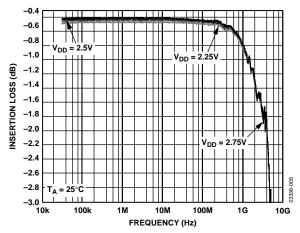


Figure 5. Insertion Loss vs. Frequency over Supplies (S12 and S21)

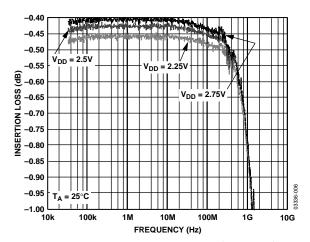


Figure 6. Insertion Loss vs. Frequency over Supplies (S12 and S21) (Zoomed Figure 5 Plot)

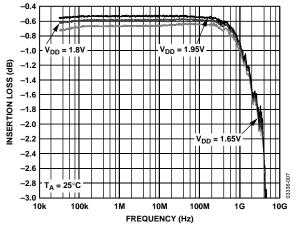


Figure 7. Insertion Loss vs. Frequency over Supplies (S12 and S21)

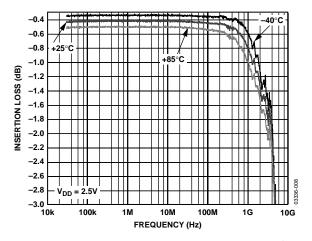


Figure 8. Insertion Loss vs. Frequency over Temperature (S12 and S21)

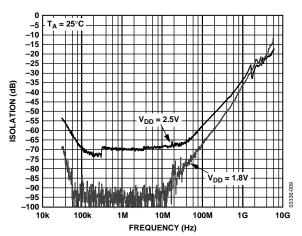


Figure 9. OFF Isolation vs. Frequency over Supplies (\$12 and \$21)

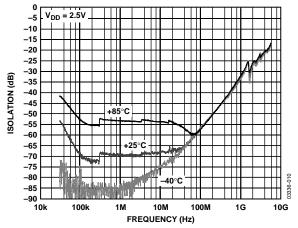


Figure 10. Off Isolation vs. Frequency over Temperature (\$12 and \$21)

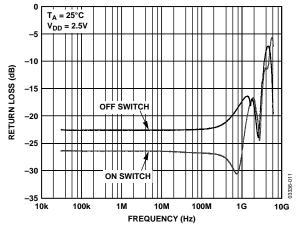


Figure 11. Return Loss vs. Frequency (S11)

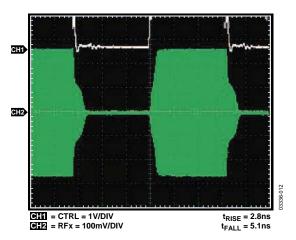


Figure 12. Switch Timing

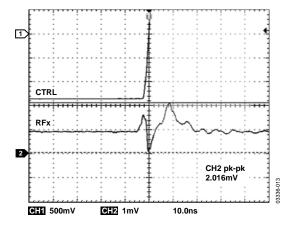


Figure 13. Video Feedthrough

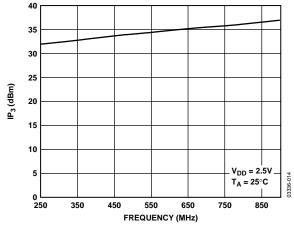


Figure 14. IP₃ vs. Frequency

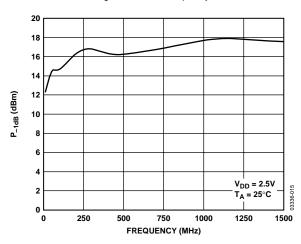


Figure 15. P<sub>-1dB</sub> vs. Frequency

### **TERMINOLOGY**

 $\mathbf{V}_{DD}$ 

Most positive power supply potential.

 $\mathbf{I}_{\mathrm{DD}}$ 

Positive supply current.

**GND** 

Ground (0 V) reference.

CTRL

Logic control input.

 $V_{\text{INL}}$ 

Maximum input voltage for Logic 0.

 $V_{INH}$ 

Minimum input voltage for Logic 1.

I<sub>IN</sub>L (I<sub>INH</sub>)

Input current of the digital input.

CIN

Digital input capacitance.

ton

Delay between applying the digital control input and the output switching on.

 $t_{OFF}$ 

Delay between applying the digital control input and the output switching off.

trise

Rise time. Time for the RF signal to rise from 10% to 90% of the on level.

#### **t**fall

Fall time. Time for the RF signal to fall from 90% to 10% of the on level.

### Off Isolation

The attenuation between input and output ports of the switch when the switch control voltage is in the off condition.

#### **Insertion Loss**

The attenuation between input and output ports of the switch when the switch control voltage is in the on condition.

### $P_{-1 dB}$

1 dB compression point. The RF input power level at which the switch insertion loss increases by 1 dB over its low level value. It is a measure of how much power the on switch can handle before the insertion loss increases by 1 dB.

#### $IP_3$

Third-order intermodulation intercept. This is a measure of the power in false tones that occur when closely spaced tones are passed through a switch, whereby the nonlinearity of the switch causes these false tones to be generated.

### **Return Loss**

The amount of reflected power relative to the incident power at a port. Large return loss indicates good matching. By measuring return loss the VSWR can be calculated from conversion charts. voltage standing wave ratio (VSWR) indicates the degree of matching present at a switch RF port.

### Video Feedthrough

The spurious signals present at the RF ports of the switch when the control voltage is switched from high to low or low to high without an RF signal present.

## **TEST CIRCUITS**

Similar setups for ADG902.

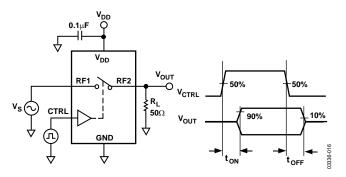


Figure 16. Switching Timing: ton, toff

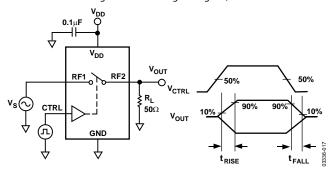


Figure 17. Switch Timing: trise, tfall

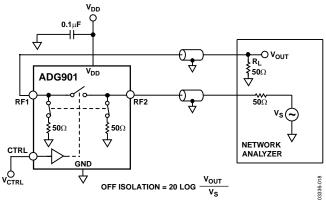


Figure 18. Off Isolation

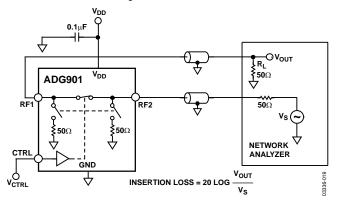


Figure 19. Insertion Loss

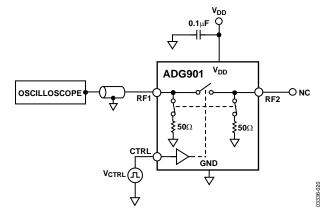


Figure 20. Video Feedthrough

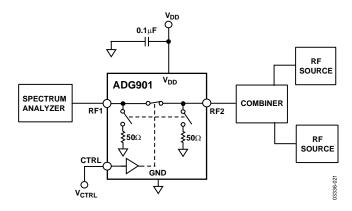


Figure 21. IP₃

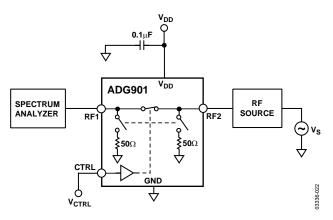


Figure 22. P<sub>-1 dB</sub>

### **APPLICATIONS**

The ADG901/ADG902 are ideal solutions for low power, high frequency applications. The low insertion loss, high isolation between ports, low distortion, and low current consumption of these parts make them excellent solutions for many high frequency switching applications.

Applications include switching between high frequency filters, ASK generators, and FSK generators.

### **ABSORPTIVE vs. REFLECTIVE SWITCHES**

The ADG901 is an absorptive (matched) switch with 50  $\Omega$  terminated shunt legs and the ADG902 is a reflective switch with 0  $\Omega$  terminated shunts to ground. The ADG901 absorptive switch has a good VSWR on each port, regardless of the switch mode. An absorptive switch should be used when there is a need for a good VSWR that is looking into the port but not passing the through signal to the common port. The ADG901 is therefore ideal for applications that require minimum reflections back to the RF source. It also ensures that the maximum power is transferred to the load.

The ADG902 reflective switch is suitable for applications where high off port VSWR does not matter and the switch has some other desired performance feature. It can be used in many applications, including high speed filter selection. In most cases, an absorptive switch can be used instead of a reflective switch, but not vice versa.

### ADG90x EVALUATION BOARD

The ADG90x evaluation board allows designers to evaluate the high performance wideband switches with a minimum of effort. To prove that these devices meet user requirements, the user requires only a power supply and a network analyzer along with the evaluation board. An application note is available with the evaluation board and provides complete information on operating the evaluation board.

The RF1 port (see Figure 23) is connected through a 50  $\Omega$  transmission line to the top left SMA Connector J1. RF2 is connected through a 50  $\Omega$  transmission line to the top SMA Connector J2. J3 is connected to GND. A through transmission line connects J4 and J5 and this transmission line is used to estimate the loss of the PCB over the environmental conditions being evaluated.

The board is constructed of a 4-layer, FR4 material with a dielectric constant of 4.3 and an overall thickness of 0.062 inches. Two ground layers with grounded planes provide ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 0.052 inches, clearance to ground plane of 0.030 inches, dielectric thickness of 0.029 inches, and a metal thickness of 0.014 inches.

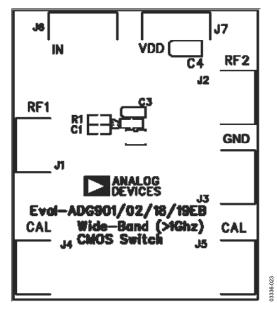
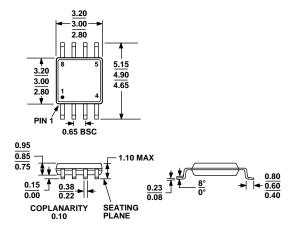


Figure 23. ADG90x Evaluation Board Top View

## **OUTLINE DIMENSIONS**



### COMPLIANT TO JEDEC STANDARDS MO-187-AA

Figure 24. 8-Lead Mini Small Outline Package [MSOP] (RM-8) Dimensions shown in millimeters

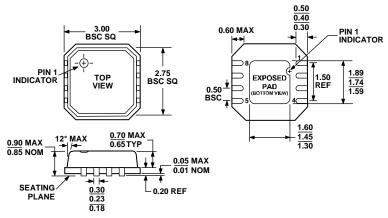


Figure 25. 8-Lead Lead Frame Chip Scale Package [LFCSP] 3 mm × 3 mm Body (CP-8-2) Dimensions shown in millimeters

### **ORDERING GUIDE**

Model Temperature Range		Package Description	Package Option	Branding	
ADG901BRM	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	W6B	
ADG901BRM-500RL7	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	W6B	
ADG901BRM-REEL7	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	W6B	
ADG901BRMZ <sup>1</sup>	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S1T	
ADG901BRMZ-REEL7 <sup>1</sup>	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S1T	
ADG901BCP-500RL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	W6B	
ADG901BCP-REEL7	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	W6B	
ADG901BCPZ-REEL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	S1T	
ADG902BRM	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	W7B	
ADG902BRM-500RL7	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	W7B	
ADG902BRM-REEL7	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	RM-8	W7B	
ADG902BRMZ <sup>1</sup>	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S1V	
ADG902BCP-500RL7	−40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	W7B	
ADG902BCP-REEL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	W7B	
ADG902BCP-REEL7	-40°C to +85°C	8-Lead Lead Frame Chip Scale Package [LFCSP]	CP-8-2	S1V	
EVAL-ADG901EB		Evaluation Board			
EVAL-ADG902EB		Evaluation Board			

 $<sup>^{1}</sup>$  Z = Pb-free part.

**Preliminary Technical Data** 

## **NOTES**

## **NOTES**

ΔΠ	)Çq	<b>N1</b>	/AD	Çq	<b>N</b> 2
ЛЦ	uJ	U I	IND	uυ	υL

**Preliminary Technical Data** 

**NOTES**